

DFM300PXM18-A000

Fast Recovery Diode Module

DS6422-1 June 2023 (LN42612)

FEATURES

- Low Reverse Recovery Charge
- High Switching Speed
- Low Forward Volt Drop
- Isolated AISiC Base With AIN Substrates
- Lead Free Construction

APPLICATIONS

- Chopper Diodes
- Boost and Buck Converters
- Free-wheel Circuits
- Multi-level Switch Inverters

The DFM300PXM18-A000 is a series pair 1800V, fast recovery diode (FRD) module. Designed for low power loss, the module is suitable for a variety of high voltage applications in motor drives and power conversion.

Fast switching times and low reverse recovery losses allow high frequency operation, making the device suitable for the latest drive designs employing PWM and high frequency switching.

The module incorporates an electrically isolated base plate and low inductance construction enabling circuit designers to optimise circuit layouts and utilise grounded heat sinks for safety.

ORDERING INFORMATION

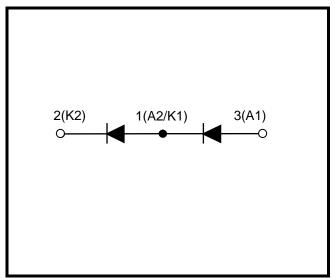
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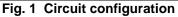
DFM300PXM18-A000

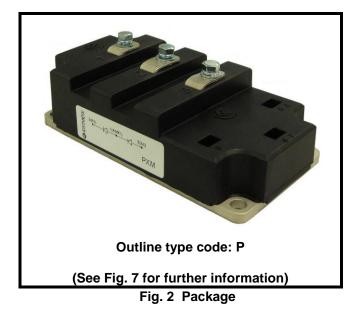
Note: When ordering, please use the complete part number

KEY PARAMETERS

V _{RRM}		1800V
VF	(typ)	2.0V
I _F	(max)	300A
I _{FM}	(max)	600A







ABSOLUTE MAXIMUM RATINGS

Stresses above those listed under 'Absolute Maximum Ratings' may cause permanent damage to the device. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture of the package. Appropriate safety precautions should always be followed. Exposure to Absolute Maximum Ratings may affect device reliability.

T_{case} = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Vrrm	Repetitive peak reverse voltage	T _j = 125°C	1800	V
١F	Forward current (per arm)	DC, $T_{case} = 75^{\circ}C$, $T_j = 125^{\circ}C$	300	А
IFM	Max. forward current (per arm)	$T_{case} = 110^{\circ}C, t_{p} = 1ms$	600	А
l²t	I ² t value fuse current rating	$V_R = 0, t_p = 10ms, T_j = 125^{\circ}C$	30	kA²s
P _{max}	Max. power dissipation	$T_{case} = 25^{\circ}C, T_j = 125^{\circ}C$	1250	W
Visol	Isolation voltage – per module	Commoned terminals to base plate. AC RMS, 1 min, 50Hz	4000	V
QPD	Partial discharge – per module	IEC1287, $V_1 = 1900V$, $V_2 = 1400V$, 50Hz RMS	10	рС

THERMAL AND MECHANICAL RATINGS

Internal insulation material:	AIN
Baseplate material:	AlSiC
Creepage distance:	33mm
Clearance:	20mm
CTI (Comparative Tracking Index):	>600

Symbol	Parameter	Test Conditions	Min	Тур.	Мах	Units
R _{th(j-c)}	Thermal resistance (per arm)	Continuous dissipation – junction to case	-	-	80	°C/kW
Rth(c-h)	Thermal resistance –Mounting torque 5Nmcase to heatsink (per module)(with mounting grease)		-	-	16	°C/kW
Tj	Junction temperature		-40	-	125	°C
T _{stg}	Storage temperature range		-40	-	125	°C
		Mounting – M6	-	-	5	Nm
	Screw Torque	Electrical connections – M5	-	-	4	Nm

STATIC ELECTRICAL CHARACTERISTICS – PER ARM

T_{case} = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
I _{RM}	Peak reverse current	$V_R = 1800V, T_j = 125^{\circ}C$			5	mA
VF	Forward voltage	IF = 300A		2.0	2.3	V
		I _F = 300A, T _j = 125°C		2.0	2.3	V
Lм	Inductance – per diode	-		40		nH

DYNAMIC ELECTRICAL CHARACTERISTICS – PER ARM

T_{case} = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
Qrr	Reverse recovery charge	I⊧ = 300A		90		μC
I _{rr}	Peak reverse recovery current V _R = 900V			250		А
Erec	Reverse recovery energy	dl⊧/dt = 1500A/µs		70		mJ

T_{case} = 125°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
Qrr	Reverse recovery charge			150		μC
١'n	Peak reverse recovery current	V _R = 900V		285		А
Erec	Reverse recovery energy	dl _F /dt = 1500A/µs		100		mJ

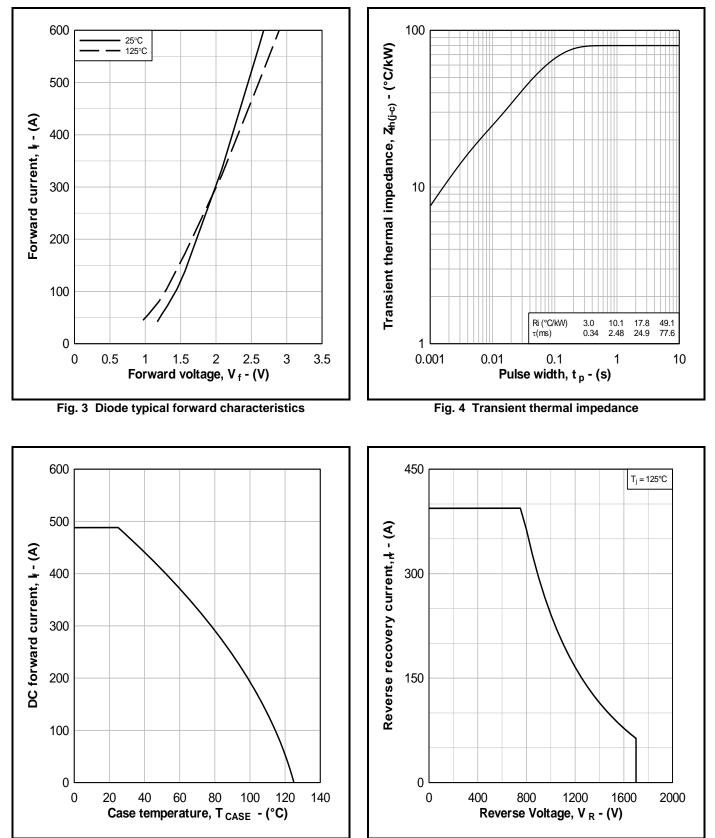
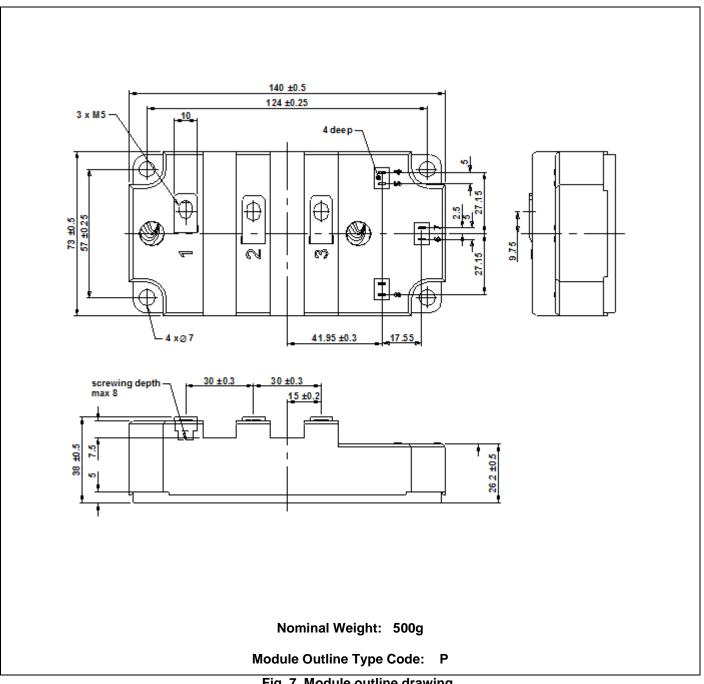


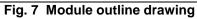
Fig. 5 DC current rating vs case temperature

Fig. 6 Reverse Bias Safe Operating Area (RBSOA)

PACKAGE DETAILS

For further package information, please visit our website or contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.





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DYNEX SEMICONDUCTOR LTD

Doddington Road, Lincoln, Lincolnshire, LN6 3LF, United Kingdom Fax: +44(0)1522 500550 Tel: +44(0)1522 500500 Web: <u>http://www.dynexsemi.com</u>

CUSTOMER SERVICE

DYNEX SEMICONDUCTOR LTD

Doddington Road, Lincoln, Lincolnshire, LN6 3LF, United Kingdom

Tel: +44(0)1522 502753 / 502901 Email: <u>powersolutions@dynexsemi.com</u>

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